

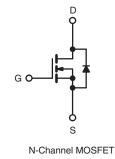
**Vishay Siliconix** 



### **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	400				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V	0.55			
Q <sub>g</sub> (Max.) (nC)	62				
Q <sub>gs</sub> (nC)	10				
Q <sub>gd</sub> (nC)	30				
Configuration	Single				





#### FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-247AC package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220AB devices. The TO-247AC is similar but superior to the earlier TO-218 package because its isolated mounting hole. It also provides greater creepage distances between pins to meet the requirements of most safety specifications.

ORDERING INFORMATION		
Package	TO-247AC	
Lead (Pb)-free	IRFP340PbF	
	SiHFP340-E3	
SnPb	IRFP340	
	SiHFP340	

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \degree C$ , unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V <sub>DS</sub>	400	v		
Gate-Source Voltage			V <sub>GS</sub>			± 20
Continuous Drain Current	$V_{GS}$ at 10 V $\frac{T_C = 25 \degree C}{T_C = 100 \degree C}$		11			
	V <sub>GS</sub> at 10 V T <sub>C</sub> =	T <sub>C</sub> = 100 °C	ID	6.9	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	44	1	
Linear Derating Factor				1.2	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	480	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	11	А	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub> 15		mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		PD	150	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	4.0	V/ns	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C		
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>		
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in	
				1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD} = 50 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ , L = 6.9 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 11 \text{ A}$  (see fig. 12).

c.  $I_{SD} \le 11$  A, dl/dt  $\le 120$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		40					
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.24		-		°C/W			
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-		0.83		1			
	I	-							
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ ,	unless otherv	vise noted)							
PARAMETER	SYMBOL		CONDITIC	ONS	MIN.	TYP.	MAX.	UNIT	
Static		1				<b>I</b>		1	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	) V, I <sub>D</sub> = 25	0 μA	400	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I <sub>I</sub>	<sub>0</sub> = 1 mA	-	0.49	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		2.0	-	4.0	V		
Gate-Source Leakage	I <sub>GSS</sub>	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA		
		$V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 320 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$		-	-	25	μA		
Zero Gate Voltage Drain Current	IDSS			-	-	250			
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub>	= 6.6 A <sup>b</sup>	-	-	0.55	Ω	
Forward Transconductance	g <sub>fs</sub>	V <sub>DS</sub> = 5	50 V, I <sub>D</sub> = 6	.6 A <sup>b</sup>	7.7	-	-	S	
Dynamic		1				<b>I</b>		1	
Input Capacitance	C <sub>iss</sub>		( 0.)/		-	1400	-		
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	400	-	pF		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	130	-			
Total Gate Charge	Qg			10 A, V <sub>DS</sub> = 320 V, 1 e fig. 6 and 13 <sup>b</sup>	-	-	62	nC	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V			-	-	10		
Gate-Drain Charge	Q <sub>gd</sub>		see lig		-	-	30	1	
Turn-On Delay Time	t <sub>d(on)</sub>				-	14	-		
Rise Time	t <sub>r</sub>	- V 2	00 \/ I	10 A	-	27	-	1	
Turn-Off Delay Time	t <sub>d(off)</sub>	$ \begin{array}{l} V_{DD} = 200 \; V, \; I_{D} = 10 \; A \; , \\ R_{g} = 9.1 \; \Omega, \; R_{D} = 20 \; \Omega, \; \text{see fig. } 10^{b} \end{array} $		-	50	-	ns		
Fall Time	t <sub>f</sub>	1			-	24	-	1	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	5.0	-	nH		
Internal Source Inductance	L <sub>S</sub>			-	13	-			
Drain-Source Body Diode Characteristic	cs								
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	11	А		
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	44			
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C, I	<sub>S</sub> = 11 A, \	$V_{\rm GS} = 0 \ \rm V^b$	-	-	2.0	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}^b$		-	330	660	ns		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	2.5	5.9	μC		
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn			-on is do	minated b	by $L_S$ and $L_D$ )		

#### Notes

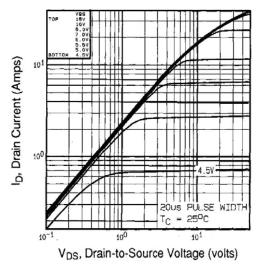
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$ 

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



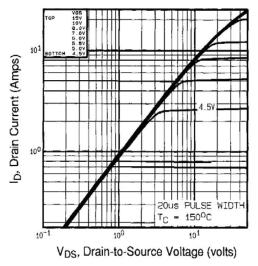


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 150 °C

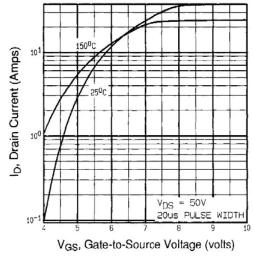


Fig. 3 - Typical Transfer Characteristics

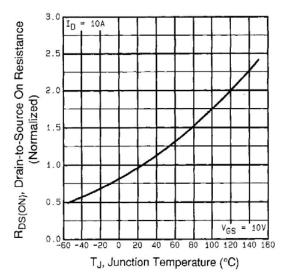


Fig. 4 - Normalized On-Resistance vs. Temperature

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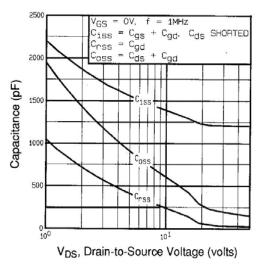


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

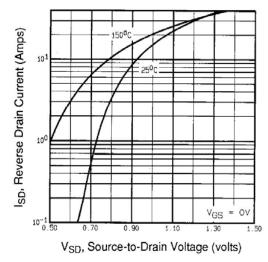


Fig. 7 - Typical Source-Drain Diode Forward Voltage

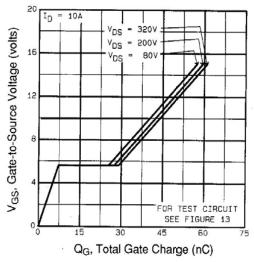
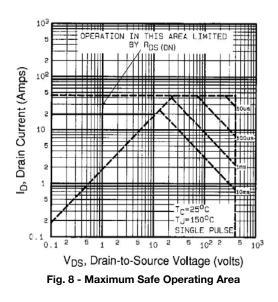


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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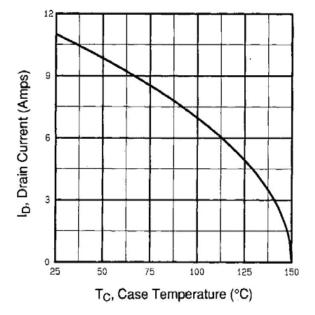


Fig. 9 - Maximum Drain Current vs. Case Temperature

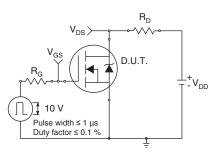


Fig. 10a - Switching Time Test Circuit

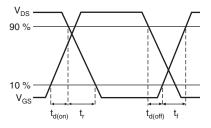


Fig. 10b - Switching Time Waveforms

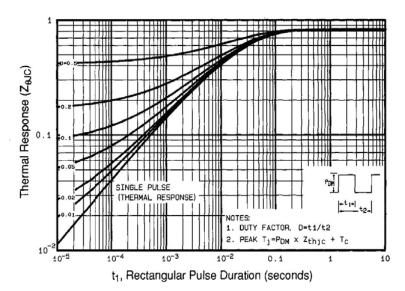


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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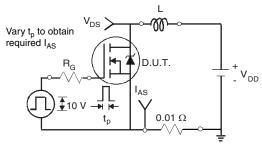


Fig. 12a - Unclamped Inductive Test Circuit

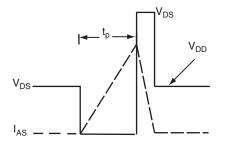
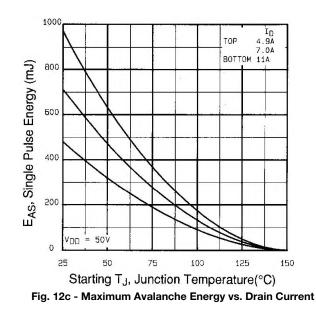


Fig. 12b - Unclamped Inductive Waveforms



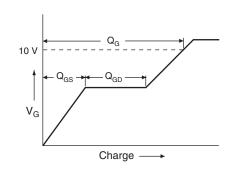
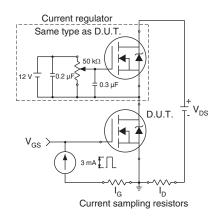
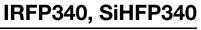


Fig. 13a - Basic Gate Charge Waveform



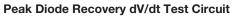


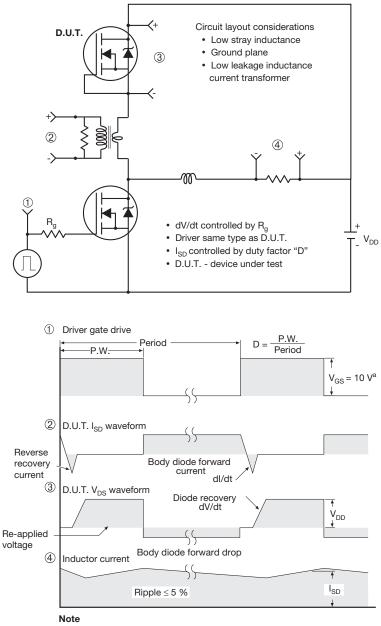
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a.  $V_{GS} = 5$  V for logic level devices

Fig. 14 - For N-Channel

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<sup>7</sup> 

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### TO-247AC (High Voltage)

ECN: X13-0103-Rev. D, 01-Jul-13 DWG: 5971

#### Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Contour of slot optional.

 Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.

4. Thermal pad contour optional with dimensions D1 and E1.

5. Lead finish uncontrolled in L1.

6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").

7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.

8. Xian and Mingxin actually photo.





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